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AH3774

HIGH-VOLTAGE HIGH-SENSITIVITY HALL EFFECT LATCH

Description

The AH3774 is a high-voltage, high-sensitivity Hall Effect Latch IC designed for commutation of brushless DC motor, flow meters, linear encoders and position sensors in industrial and consumer home appliance and personal care applications. To support a wide range of demanding applications, the design is optimized to operate over the supply range of 3.0V to 28V. With chopper stabilized architecture and an internal bandgap regulator to provide temperature compensated supply for internal circuits, the AH3774 provides a reliable solution over the whole operating range. For robustness and protection, the device has a reverse blocking diode with a Zener clamp on the supply. The output has an over current limit and a Zener clamp.

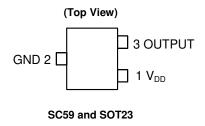
The single open-drain output can be switched on with South Pole of sufficient strength and switched off with North Pole of sufficient strength. When the magnetic flux density (B) perpendicular to the package is larger than the operate point (Bop) the output is switched on (pulled low). The output is held latched until magnetic flux density reverses and becomes lower than the release point (Brp).

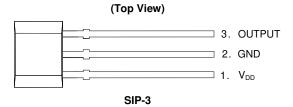
The magnetic operating and release polarity is opposite for SOT23 and SC59 packages. SOT23 and SIP-3 packages will require South Pole to the part marking side to operate while SC59 will require South Pole to the non-part marking side.

Features

- Bipolar Latch (South Pole: On, North Pole: Off)
- 3.0V to 28V Operating Voltage Range
- High Sensitivity: Bop and Brp of +40G and -40G Typical
- Single Open Drain Output with Over Current Limit
- Chopper Stabilized Design Provides
 - Superior Temperature Stability
 - Minimal Switch Point Drift
 - Enhanced Immunity to Stress
- Good RF Noise Immunity
- Reverse Blocking Diode and Zener Clamp on Supply
- -40°C to +125°C Operating Temperature
- ESD (HBM): 6kV
- Industry Standard SC59, SOT23 and SIP-3 Packages
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Pin Assignments





Applications

- Brushless DC Motor Commutation
- · Revolution Per Minute (RPM) Measurement
- Flow Meters
- · Angular and Linear Encoder and Position Sensors
- Contact-less Commutation, Speed Measurement and Angular Position Sensing/Indexing in Consumer Home Appliances, Office Equipments and Industrial Applications

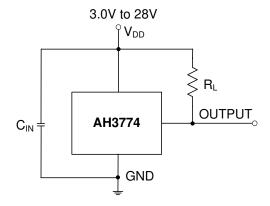
Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.





Typical Applications Circuit



Note:

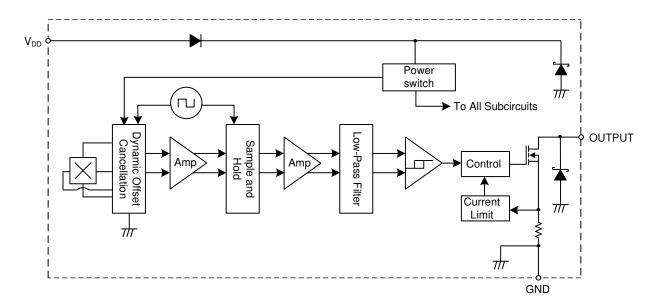
4. C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 10nF \sim 100nF. R_L is the pull-up resistor.

Pin Descriptions

Package: SC59, SOT23 and SOT23

Pin Number	Pin Name	Function				
1	V_{DD}	Power Supply Input				
2	GND	Ground				
3	OUTPUT	Output Pin				

Functional Block Diagram







Absolute Maximum Ratings (Notes 5 & 6) (@TA = +25°C, unless otherwise specified.)

Symbol	Characteristic		Value	Unit	
V_{DD}	Supply Voltage (Note 6)		32	V	
V_{DDR}	Reverse supply voltage		-32	V	
V _{OUT_MAX}	Output off voltage (Note 6)		32V	V	
l _{out}	Continuous output current	60	mA		
I _{OUT_R}	Reverse output current	-50	mA		
В	Magnetic Flux Density		Unlimited		
В	Package Power Dissipation	SIP-3	550	mW	
P_{D}	Package Power Dissipation	SC59 and SOT23	-50 n Unlimited 550 m 230 -65 to +165		
Ts	Storage Temperature Range		-65 to +165	°C	
T_J	Maximum Junction Temperature	150	°C		
ESD	Electrostatic Discharge Withstand Capability - Human Body M	odel	6	kV	

Notes:

- 5. Stresses greater than the "Absolute Maximum Ratings" specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
- 6. The absolute maximum V_{DD} of 32V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

Recommended Operating Conditions (@T_A = -40°C to +125°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V_{DD}	Supply Voltage	Operating	3.0 to 28	V
T _A	Operating Temperature Range	Operating	-40 to +125	°C

$\textbf{Electrical Characteristics} \ \, (\text{Notes 7 \& 8}) \ \, (\text{@T}_{\text{A}} = -40^{\circ}\text{C to } + 125^{\circ}\text{C}, \, \text{V}_{\text{DD}} = 3\text{V to 28V}, \, \text{unless otherwise specified.})$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
mW	Output On Voltage	I _{OUT} = 20mA, B > Bop		0.2	0.4	V
I _{OUT_OFF}	Output Leakage Current	V _{OUT} = 28V, B < Brp, Output Off	_	<0.1	10	μΑ
I	Supply Current	Output Open, T _A = +25°C	1	3	1	mA
I _{DD}		Output Open, T _A = -40°C to +125°C	1	_	4	mA
I _{DD R}	Reverse Battery Current	$V_{DD} = -18V$, $T_A = -40$ °C to $+125$ °C	1	-0.01	1	mA
IDD_R	neverse battery Current	$V_{DD} = -28V$, $T_A = -40$ °C to $+125$ °C	1	-0.01	1.5	mA
t _{ST}	Device Start-Up Time	V _{DD} >= 3V, B > Bop (Note 7)	I	10	I	μs
f _c	Chopping Frequency	$V_{DD} >= 3V$		800	1	kHz
t _d	The time delay from magnetic threshold reached to the start of the output rise or fall	(Note 9)	_	3.75	_	μs
tr	Output Rising Time (external pull-up resistor R∟ and load capacitance dependent)	$R_L = 1k\Omega$, $C_L = 20pF$	ı	0.2	1	μs
t _f	Output Falling Time (Internal switch resistance and load capacitance dependent)	$R_L = 1k\Omega$, $C_L = 20pF$		0.1	1	μs
l _{OCL}	Output Current Limit	B>Bop, (Note 10)	30	_	55	mA
V_Z	Zener Clamp Voltage	I _{DD} = 5mA	28	_	_	V

Notes:

- 7. When power is initially turned on, VDD must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10µs typical from the operating voltage reaching 3V.
- 8. Typical values are defined at T_A = +25°C, V_{DD} = 12V. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization.
- 9. Guaranteed by design, process control and characterization, Not tested in production.
- 10. The device will limit the output current I_{OUT} to current limit of I_{OCL}.





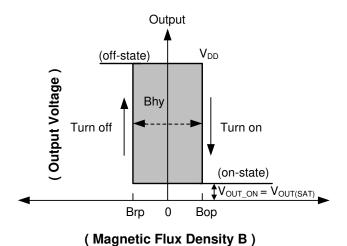


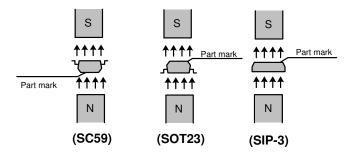
Magnetic Characteristics (Notes 11 & 12) (T_A = -40°C to +125°C, V_{DD} = 3.0V to 28V, unless otherwise specified) (1mT=10 Gauss)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
Bop (South Pole to part marking side for SOT23 and SIP-3 packages);	Operation Point	V _{DD} = 12V, T _A = +25°C	_	40			
South Pole to the non-part marking side for SC59 package. See diagram below)	Sportation 1 of the	$T_A = -40$ °C to +125°C	20	40	60		
Brp (North Pole to part marking side for SOT23 and SIP-3 packages;	Release Point	V _{DD} = 12V, T _A = +25°C	_	-40		Gauss	
North Pole to the non-part marking side for SC59 package. See diagram below)	nelease Point	$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	-60	-40	-20	Gauss	
Phy (Popyl Prayl)	Hysteresis (Note 13)	V _{DD} = 12V, T _A = +25°C	_	80	_		
Bhy (Bopx - Brpx)	Tysteresis (Note 13)	T _A = -40°C to +125°C	40	80	120		

- 11. When power is initially turned on, V_{DD} must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10µs typical from the operating voltage reaching 3V.
- 12. Typical values are defined at T_A = +25°C, V_{DD} = 12V. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization.

 13. Maximum and minimum hysteresis is guaranteed by design, process control and characterization.



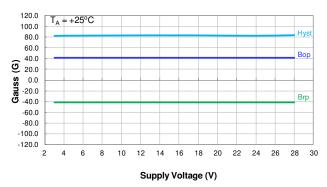




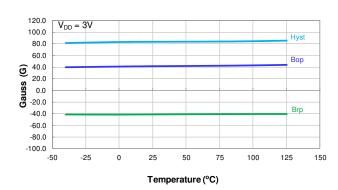


Typical Operating Characteristics

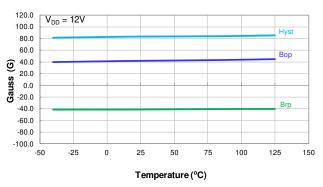
Magnetic Operating Switch Points - Bop and Brp



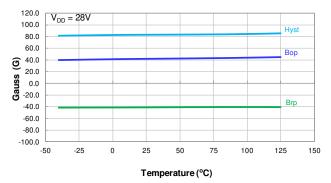
Switch Points Bop and Brp vs Supply Voltage



Switch Points Bop and Brp vs Temperature

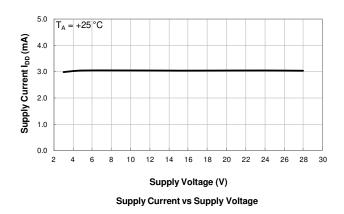


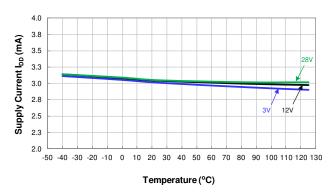
Switch Points Bop and Brp vs Temperature



Switch Points Bop and Brp vs Temperature

Supply Current





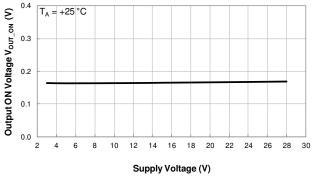
Supply Current vs Temperature



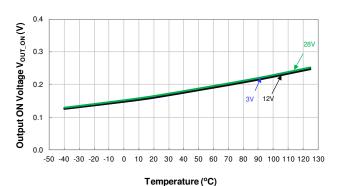


Typical Operating Characteristics (Continued)

Output Switch On Voltage

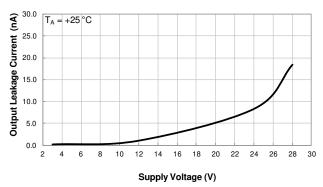


Output ON Voltage vs Supply Voltage

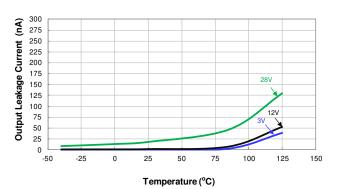


Output ON Voltage vs Temperature

Output Switch Leakage Current

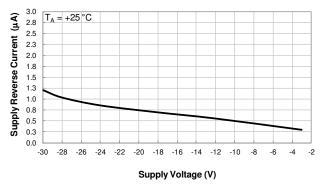


Output Leakage Current vs Supply Voltage

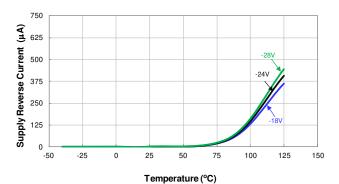


Output Leakage Current vs Temperature

Supply Reverse Current



Supply Reverse Current vs Supply Voltage



Supply Reverse Current vs Temperature

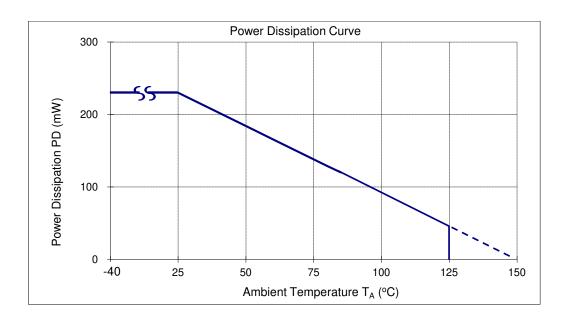




Thermal Performance Characteristics

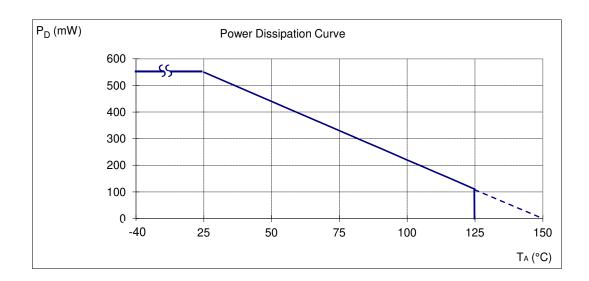
(1) Package types: SC59 and SOT23

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	230	184	166	147	129	120	110	92	83	74	55	46	37	18	0



(2) Package type: SIP-3

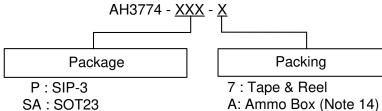
T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	550	440	396	362	308	286	264	220	198	176	132	110	88	44	0







Ordering Information (Note 16)



W : SC59 B: Bulk (Note 15)

	Package	Packaging	Е	Bulk	7" Tape an	d Reel	Amm	10 Вох
Part Number	Code	rackaging	Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH3774-P-A	Р	SIP-3	NA	NA	NA	NA	4,000/Box	-A
AH3774-P-B	Р	SIP-3	1,000	-B	NA	NA	NA	NA
AH3774-SA-7	SA	SOT23	NA	NA	3,000/Tape & Reel	-7	NA	NA
AH3774-W-7	W	SC59	NA	NA	3,000/Tape & Reel	-7	NA	NA

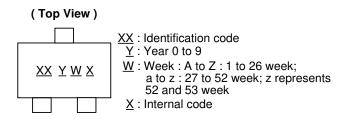
Notes: 14. Ammo Box is for SIP-3 Spread Lead.

15. Bulk is for SIP-3 Straight Lead.

16. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

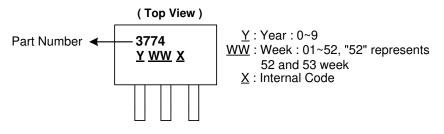
Marking Information

(1) Package Type: SC59 and SOT23



Part Number	Package	Identification Code
AH3774	SC59	YW
AH3774	SOT23	WW

(2) Package Type: SIP-3



Part Number	Package	Identification Code
AH3774	SIP-3	3774



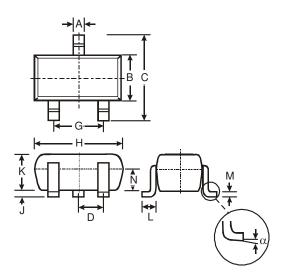




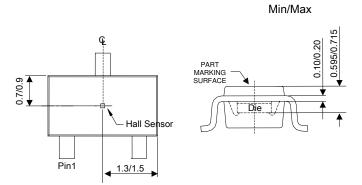
Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

(1) Package Type: SC59



	SC59								
Dim	Min	Max	Тур						
Α	0.35	0.50	0.38						
В	1.50	1.70	1.60						
С	2.70	3.00	2.80						
D	_	_	0.95						
G	_	_	1.90						
Н	2.90	3.10	3.00						
J	0.013	0.10	0.05						
K	1.00	1.30	1.10						
L	0.35	0.55	0.40						
М	0.10	0.20	0.15						
N	0.70	0.80	0.75						
α	0°	8°	_						
All	Dimens	ions in	mm						



Sensor Location



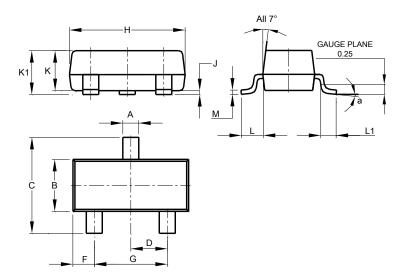




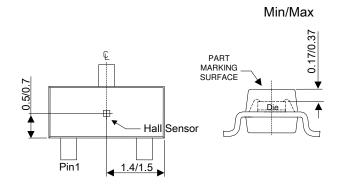
Package Outline Dimensions (Continued)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

(2) Package Type: SOT23



	SO	T23	
Dim	Min	Max	Тур
Α	0.37	0.51	0.40
В	1.20	1.40	1.30
С	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
Н	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
а		8°	
All	Dimens	ions in	mm



Sensor Location



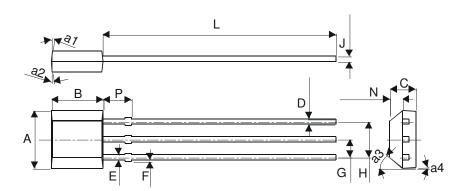




Package Outline Dimensions (Cont.)

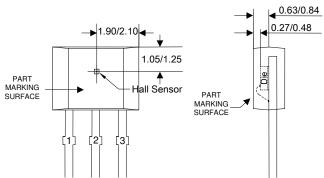
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

(3) Package Type: SIP-3 Bulk



SIP-3 (Bulk)			
Dim	Min	Max	
Α	3.9	4.3	
a1	5° Typ		
a2	5°Тур		
a3	45° Typ		
a4	3°Тур		
В	2.8	3.2	
С	1.40	1.60	
D	0.33	0.432	
Е	0.40	0.508	
F	0	0.2	
G	1.24	1.30	
Н	2.51	2.57	
J	0.35	0.43	
L	14.0	15.0	
N	0.63	0.84	
Р	1.55	_	
All Dimensions in mm			





Sensor Location



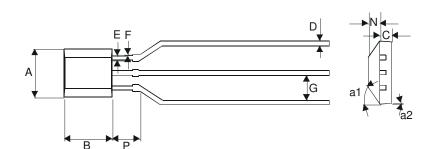




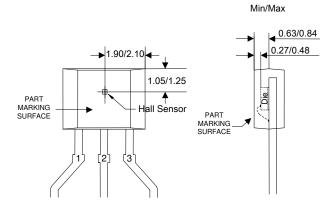
Package Outline Dimensions (Cont.)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

(4) Package Type: SIP-3 Ammo Pack



SIP-3 (Ammo Pack)		
Dim	Min	Max
Α	3.9	4.3
a1	45° Typ	
a2	3° Тур	
В	2.8	3.2
C	1.40	1.60
D	0.35	0.41
Е	0.43	0.48
F	0	0.2
G	2.4	2.9
N	0.63	0.84
Р	1.55	
All Dimensions in mm		



Sensor Location

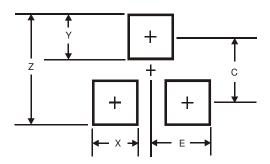






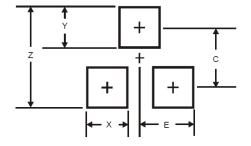
Suggested Pad Layout
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

(1) Package Type: SC59



Dimensions	Value (in mm)
Z	3.4
X	0.8
Υ	1.0
С	2.4
E	1.35

(2) Package Type: SOT23



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Υ	0.9
С	2.0
E	1.35







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 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
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